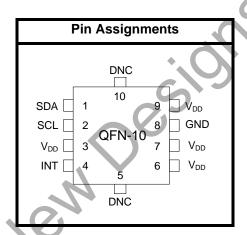


# UV INDEX AND AMBIENT LIGHT SENSOR IC WITH I2C INTERFACE

#### **Features**

- Integrated UV index sensor
  - Digital UV Index register that can be read through I<sup>2</sup>C interface
  - Factory calibration to address part-to-part variation
- Integrated ambient light sensor
  - 100 mlx resolution possible, allowing operation under dark glass
  - 1 to 128 klx dynamic range possible across two ADC range settings
  - Accurate lux measurements with IR correction algorithm

- Industry's lowest power consumption
  - 1.71 to 3.6 V supply voltage
  - < 500 nA standby current
  - Internal and external wake support
  - Built-in voltage supply monitor and power-on reset controller
- I<sup>2</sup>C Serial communications
  - Up to 3.4 Mbps data rate
  - Slave mode hardware address decoding
- Small-outline 10-lead 2x2 mm QFN
- Temperature Range
  - -40 to +85 °C



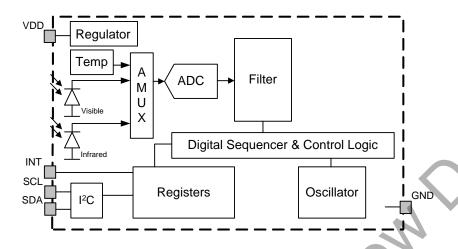
#### **Applications**

- Fitness/health electronics
- Smart watches
- Smartphone handsets
- Tablets
- Portable consumer electronics
- Display-backlighting control

#### Description

The Si1132 is a low-power, ultraviolet (UV) index, and ambient light sensor with I<sup>2</sup>C digital interface and programmable-event interrupt output. This sensor IC includes an analog-to-digital converter, integrated high-sensitivity visible and infrared photodiodes, and digital signal processor. The Si1132 offers excellent performance under a wide dynamic range and a variety of light sources including direct sunlight. The Si1132 can also work under dark glass covers. The photodiode response and associated digital conversion circuitry provide excellent immunity to artificial light flicker noise and natural light flutter noise. The Si1132 devices are provided in a 10-lead 2x2 mm QFN package and are capable of operation from 1.71 to 3.6 V over the –40 to +85 °C temperature range.

## **Functional Block Diagram**



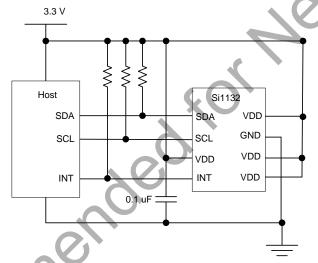


Figure 1. Si1132 Application



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# 1. Electrical Specifications

## 1.1. Performance Tables

**Table 1. Recommended Operating Conditions** 

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
V <sub>DD</sub> Supply Voltage	$V_{DD}$		1.71	_	3.6	V
V <sub>DD</sub> OFF Supply Voltage	$V_{DD\_OFF}$	OFF mode	-0.3		1.0	V
V <sub>DD</sub> Supply Ripple Voltage		$V_{DD} = 3.3 \text{ V}$ 1 kHz–10 MHz	_	~	50	mVpp
Operating Temperature	Т		-40	25	85	°C
SCL, SDA, Input High Logic Voltage	I <sup>2</sup> C <sub>VIH</sub>		V <sub>DD</sub> x0.7	17	$V_{DD}$	V
SCL, SDA Input Low Logic Voltage	I <sup>2</sup> C <sub>VIL</sub>		0	_	V <sub>DD</sub> x0.3	V
Operation under Direct Sunlight	Edc	<	_	_	128	klx
Start-Up Time		V <sub>DD</sub> above 1.71 V	25	_	_	ms

Table 2. Performance Characteristics<sup>1</sup>

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
I <sub>DD</sub> OFF Mode	I <sub>off</sub>	V <sub>DD</sub> < V <sub>DD_OFF</sub> (leakage from SCL, SDA, and INT not included)	_	240	1000	nA
I <sub>DD</sub> Standby Mode	I <sub>sb</sub>	No ALS Conversions No I <sup>2</sup> C Activity V <sub>DD</sub> = 1.8 V	_	150	500	nA
I <sub>DD</sub> Standby Mode	l <sub>sb</sub>	No ALS Conversions No I <sup>2</sup> C Activity V <sub>DD</sub> =3.3 V	_	1.4	_	μΑ
I <sub>DD</sub> Actively Measuring	I <sub>active</sub>	V <sub>DD</sub> = 3.3 V	_	4.3	5.5	mA
INT, SCL, SDA Leakage Current		V <sub>DD</sub> = 3.3 V	-1	_	1	μΑ
Actively Measuring Time <sup>2</sup>		UV or ALS VIS + ALS IR	_	285	_	μs

#### Notes:

- 1. Unless specifically stated in "Conditions", electrical data assumes ambient light levels < 1 klx.
- 2. Represents the time during which the device is drawing a current equal to I<sub>active</sub> for power estimation purposes. Assumes default settings.



Table 2. Performance Characteristics<sup>1</sup> (Continued)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Visible Photodiode Response		Sunlight ALS_VIS_ADC_GAIN=0 VIS_RANGE=0	_	0.282	_	ADC counts/
		2500K incandescent bulb ALS_VIS_ADC_GAIN=0 VIS_RANGE=0	_	0.319		ADC counts/ lux
		"Cool white" fluorescent ALS_VIS_ADC_GAIN=0 VIS_RANGE=0	_	0.146		ADC counts/ lux
		Infrared LED (875 nm) ALS_VIS_ADC_GAIN=0 VIS_RANGE=0	100	8.277	_	ADC counts. m <sup>2</sup> /W
Small Infrared Photodiode Response		Sunlight ALS_IR_ADC_GAIN=0 IR_RANGE=0		2.44		ADC counts/
		2500K incandescent bulb ALS_IR_ADC_GAIN=0 IR_RANGE=0	_	8.46	_	ADC counts/
		"Cool white" fluorescent ALS_IR_ADC_GAIN=0 IR_RANGE=0	_	0.71		ADC counts/
		Infrared LED (875 nm) ALS_IR_ADC_GAIN=0 IR_RANGE=0	_	452.38	_	ADC counts. m <sup>2</sup> /W
Visible Photodiode Noise		All gain settings	_	7	_	ADC counts RMS
Small Infrared Photodiode Noise		All gain settings		1		ADC counts RMS

#### Notes:

- 1. Unless specifically stated in "Conditions", electrical data assumes ambient light levels < 1 klx.
- 2. Represents the time during which the device is drawing a current equal to I<sub>active</sub> for power estimation purposes. Assumes default settings.



Table 2. Performance Characteristics<sup>1</sup> (Continued)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Visible Photodiode Offset Drift		VIS_RANGE=0  ALS_VIS_ADC_GAIN=0  ALS_VIS_ADC_GAIN=1  ALS_VIS_ADC_GAIN=2  ALS_VIS_ADC_GAIN=3  ALS_VIS_ADC_GAIN=4  ALS_VIS_ADC_GAIN=5  ALS_VIS_ADC_GAIN=6  ALS_VIS_ADC_GAIN=7		-0.3 -0.11 -0.06 -0.03 -0.01 -0.008 -0.007 -0.008		ADC counts/
Small Infrared Photodiode Offset Drift		IR_RANGE=0 IR_GAIN=0 IR_GAIN=1 IR_GAIN=2 IR_GAIN=3		-0.3 -0.06 -0.03 -0.01	_	ADC counts/ °C
SCL, SDA, INT Output Low Voltage	V <sub>OL</sub>	$I = 4 \text{ mA}, V_{DD} > 2.0 \text{ V}$ $I = 4 \text{ mA}, V_{DD} < 2.0 \text{ V}$	_ _		V <sub>DD</sub> x0. 2 0.4	V V
Temperature Sensor Offset		25 °C	_	11136	_	ADC counts
Temperature Sensor Gain		960	_	35	_	ADC counts/ °C

- Unless specifically stated in "Conditions", electrical data assumes ambient light levels < 1 klx.</li>
   Represents the time during which the device is drawing a current equal to I<sub>active</sub> for power estimation purposes. Assumes default settings.



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Table 3. I<sup>2</sup>C Timing Specifications

Parameter	Symbol	Min	Тур	Max	Unit
Clock Frequency	f <sub>SCL</sub>	95	_	3400	kHz
Clock Pulse Width Low	t <sub>LOW</sub>	160	_	_	ns
Clock Pulse Width High	t <sub>HIGH</sub>	60	_	_	ns
Rise Time	t <sub>R</sub>	10	_	40	ns
Fall Time	t <sub>F</sub>	10	_	40	ns
Start Condition Hold Time	t <sub>HD.STA</sub>	160	-/	10	ns
Start Condition Setup Time	t <sub>SU.STA</sub>	160	_	<i>/</i> _	ns
Input Data Setup Time	t <sub>SU.DAT</sub>	10	Est	_	ns
Input Data Hold Time	t <sub>HD.DAT</sub>	0		_	ns
Stop Condition Setup Time	t <sub>SU.STO</sub>	160	<b>/</b> –	_	ns

**Table 4. Absolute Maximum Limits** 

Parameter	Test Condition	Min	Тур	Max	Unit
V <sub>DD</sub> Supply Voltage	7	-0.3	_	4	V
Operating Temperature	80,	-40	_	85	°C
Storage Temperature	70	-65	_	85	°C
INT, SCL, SDA Voltage	at V <sub>DD</sub> = 0 V, T <sub>A</sub> < 85 °C	-0.5	_	3.6	V
ESD Rating	Human Body Model Machine Model Charged-Device Model	_ _ _		2 225 2	kV V kV

# 1.2. Typical Performance Graphs

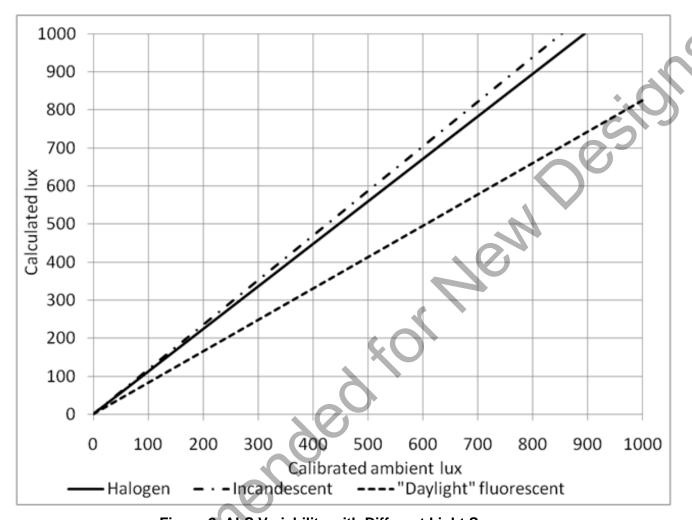


Figure 2. ALS Variability with Different Light Sources



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# 2. Functional Description

#### 2.1. Introduction

The Si1132 is a UV index and ambient light sensor whose operational state is controlled through registers accessible through the I<sup>2</sup>C interface. The host can command the Si1132 to initiate on-demand UV index sensing or ambient light sensing. The host can also place the Si1132 in an autonomous operational state where it performs measurements at set intervals and interrupts the host after each measurement is completed. This results in an overall system power saving allowing the host controller to operate longer in its sleep state instead of polling the Si1132. For more details, refer to "AN498: Si114x Designer's Guide".

## 2.2. Ambient Light

The Si1132 has photodiodes capable of measuring both visible and infrared light. However, the visible photodiode is also influenced by infrared light. The measurement of illuminance requires the same spectral response as the human eye. If an accurate lux measurement is desired, the extra IR response of the visible-light photodiode must be compensated. Therefore, to allow the host to make corrections to the infrared light's influence, the Si1132 reports the infrared light measurement on a separate channel. The separate visible and IR photodiodes lend themselves to a variety of algorithmic solutions. The host can then take these two measurements and run an algorithm to derive an equivalent lux level as perceived by a human eye. Having the IR correction algorithm running in the host allows for the most flexibility in adjusting for system-dependent variables. For example, if the glass used in the system blocks visible light more than infrared light, the IR correction needs to be adjusted.

If the host is not making any infrared corrections, the infrared measurement can be turned off in the CHLIST parameter.

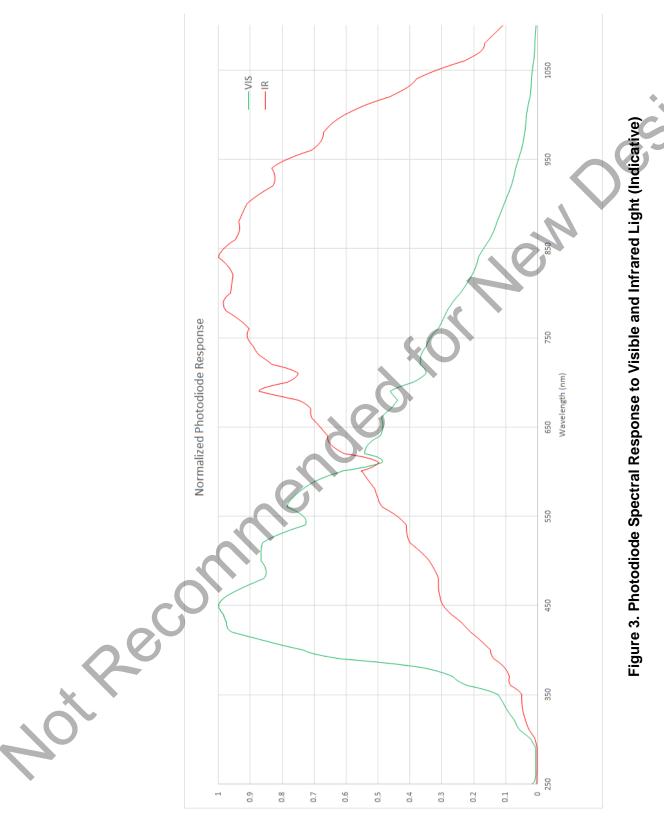
By default, the measurement parameters are optimized for indoor ambient light levels where it is possible to detect light levels as low as 6 lx. For operation under direct sunlight, the ADC can be programmed to operate in a high signal operation so that it is possible to measure direct sunlight without overflowing the 16-bit result.

For low-light applications, it is possible to increase the ADC integration time. Normally, the integration time is 25.6 µs. By increasing this integration time to 410 µs, the ADC can detect light levels as low as 1 lx. The ADC can be programmed with an integration time as high as 3.28 ms, allowing measurement to 100 mlx light levels. The ADC integration time for the Visible Light Ambient measurement can be programmed independently of the ADC integration time of the Infrared Light Ambient measurement. The independent ADC parameters allow operation under glass covers having a higher transmittance to Infrared Light than Visible Light.

When operating in the lower signal range, or when the integration time is increased, it is possible to saturate the ADC when the ambient light suddenly increases. Any overflow condition is reported in the RESPONSE register, and the corresponding data registers report a value of 0xFFF. Based on either of these two overflow indicators, the host can adjust the ADC sensitivity. However, the overflow condition is not sticky. If the light levels return to a range within the capabilities of the ADC, the corresponding data registers begin to operate normally. The RESPONSE register will continue to hold the overflow condition until a NOP command is received. Even if the RESPONSE register has an overflow condition, commands are still accepted and processed.

The Si1132 can initiate ALS measurements either when explicitly commanded by the host or periodically through an autonomous process. Refer to "3. Operational Modes" on page 15 for additional details of the Si1132's Operational Modes.







## 2.3. Ultraviolet (UV) Index

The UV Index is a number linearly related to the intensity of sunlight reaching the earth and is weighted according to the CIE Erythemal Action Spectrum as shown in Figure 4. This weighting is a standardized measure of human skin's response to different wavelengths of sunlight from UVB to UVA. The UV Index has been standardized by the World Health Organization and includes a simplified consumer UV exposure level as shown in Figures 5 and 6.

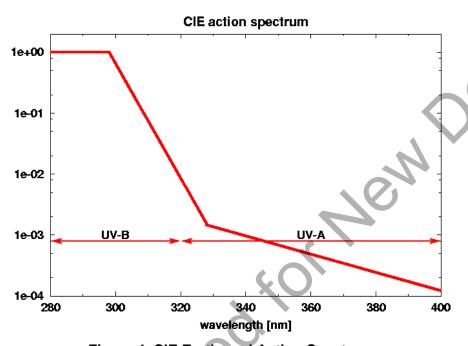


Figure 4. CIE Erythemal Action Spectrum



Figure 5. UV Index Scale



Figure 6. UV Levels



# Si1132

To enable UV reading, set the EN\_UV bit in CHLIST, and configure UCOEF [0:3] to the default values of 0x7B, 0x6B, 0x01, and 0x00. Also set the VIS\_RANGE and IR\_RANGE bits. If the sensor will be under an overlay that is not 100% transmissive to sunlight, contact Silicon Labs for more information on adjusting these coefficients.

Typically, after 285 µs, AUX\_DATA will contain a 16-bit value representing 100 times the sunlight UV Index. Host software must divide the results from AUX\_DATA by 100.

The accuracy of UV readings can be improved by using calibration parameters that are programmed into the Si1132 at Silicon Labs' production facilities to adjust for normal part-to-part variation. The calibration parameters are recovered from the Si1132 by writing Command Register @ address 0x18 with the value 0x12.

When the calibration parameters are recovered, they show up at I<sup>2</sup>C registers 0x22 to 0x2D. These are the same registers used to report the VIS, IR, and AUX measurements.

The use of calibration parameters is documented in the file, Si114x\_functions.h, which is part of the Si114x Programmer's Toolkit example source code and is downloadable from Silabs.com. The host code is expected to allocate memory for the Si114x\_CAL\_S structure. The Si114x\_calibration routine will then fill it up with the appropriate values.

Once the calibration parameters have been recovered the routine Si114x\_set\_ucoef is used to modify the default values that go into the UCOEF0 to UCOEF3 UV configuration registers to remove normal part-to-part variation.

The typical calibrated UV sensor response vs. calculated ideal UV Index is shown in Figure 7 for a large database of sunlight spectra from cloudy to sunny days and at various angles of the sun/time of day.

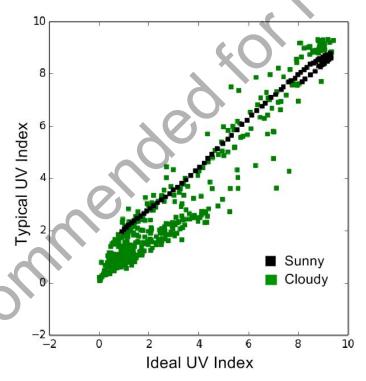


Figure 7. Calibrated UV Sensor Response vs. Calculated Ideal UV Index (AUX\_DATA Measurement / 100)



#### 2.4. Host Interface

The host interface to the Si1132 consists of three pins:

- SCL
- SDA
- INT

SCL and SDA are standard open-drain pins as required for I<sup>2</sup>C operation.

The Si1132 asserts the INT pin to interrupt the host processor. The INT pin is an open-drain output. A pull-up resistor is needed for proper operation. As an open-drain output, it can be shared with other open-drain interrupt sources in the system.

For proper operation, the Si1132 is expected to fully complete its Initialization Mode prior to any activity on the I<sup>2</sup>C. The INT, SCL, and SDA pins are designed so that it is possible for the Si1132 to enter the Off Mode by software command without interfering with normal operation of other I<sup>2</sup>C devices on the bus.

The Si1132  $I^2C$  slave address is 0x60. The Si1132 also responds to the global address (0x00) and the global reset command (0x06). Only 7-bit  $I^2C$  addressing is supported; 10-bit  $I^2C$  addressing is not supported. Conceptually, the  $I^2C$  interface allows access to the Si1132 internal registers. Table 11 on page 24 is a summary of these registers.

An  $I^2C$  write access always begins with a start (or restart) condition. The first byte after the start condition is the  $I^2C$  address and a read-write bit. The second byte specifies the starting address of the Si1132 internal register. Subsequent bytes are written to the Si1132 internal register sequentially until a stop condition is encountered. An  $I^2C$  write access with only two bytes is typically used to set up the Si1132 internal address in preparation for an  $I^2C$  read.

The  $I^2C$  read access, like the  $I^2C$  write access, begins with a start or restart condition. In an  $I^2C$  read, the  $I^2C$  master then continues to clock SCK to allow the Si1132 to drive the  $I^2C$  with the internal register contents.

The Si1132 also supports burst reads and burst writes. The burst read is useful in collecting contiguous, sequential registers. The Si1132 register map was designed to optimize for burst reads for interrupt handlers, and the burst writes are designed to facilitate rapid programming of commonly used fields.

The internal register address is a six-bit (bit 5 to bit 0) plus an Autoincrement Disable (on bit 6). The Autoincrement Disable is turned off by default. Disabling the autoincrementing feature allows the host to poll any single internal register repeatedly without having to keep updating the Si1132 internal address every time the register is read.

It is recommended that the host should read measurements (in the I<sup>2</sup>C Register Map) when the Si1132 asserts INT. Although the host can read any of the Si1132's I<sup>2</sup>C registers at any time, care must be taken when reading 2-byte measurements outside the context of an interrupt handler. The host could be reading part of the 2-byte measurement when the internal sequencer is updating that same measurement coincidentally. When this happens, the host could be reading a hybrid 2-byte quantity whose high byte and low byte are parts of different samples. If the host must read these 2-byte registers outside the context of an interrupt handler, the host should "double-check" a measurement if the measurement deviates significantly from a previous reading.

**I<sup>2</sup>C Broadcast Reset:** The I<sup>2</sup>C Broadcast Reset should be sent prior to any I<sup>2</sup>C register access to the Si1132. If any I<sup>2</sup>C register or parameter has already been written to the Si1132 when the I<sup>2</sup>C Broadcast Reset is issued, the host must send a reset command and reinitialize the Si1132 completely.

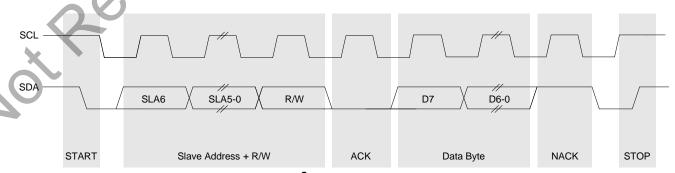


Figure 8. I<sup>2</sup>C Bit Timing Diagram





Figure 9. Host Interface Single Write

S SLAVE ID 1 A DATA N STOP

Figure 10. Host Interface Single Read

S SLAVE ID 0 A REG ADDRESS A DATA A DATA A P

Figure 11. Host Interface Burst Write

S SLAVE ID 0 A REG ADDRESS A Sr SLAVE ID 1 DATA A DATA N STOP

Figure 12. Host Interface Burst Read

7	6	5:0
0	ΑI	6 bit address 0x00 to 0x3F

Figure 13. Si1132 REG ADDRESS Format

#### Notes:

- Gray boxes are driven by the host to the Si1132
- White boxes are driven by the Si1132 to the host
- A = ACK or "acknowledge"
- N = NACK or "no acknowledge"
- S = START condition
- Sr = repeat START condition
- P = STOP condition
- AI = Disable Auto Increment when set



# 3. Operational Modes

The Si1132 can be in one of many operational modes at any one time. It is important to consider the operational mode since the mode has an impact on the overall power consumption of the Si1132. The various modes are:

- Off Mode
- Initialization Mode
- Standby Mode
- Forced Conversion Mode
- Autonomous Mode

#### 3.1. Off Mode

The Si1132 is in the Off Mode when  $V_{DD}$  is either not connected to a power supply or if the  $V_{DD}$  voltage is below the stated VDD\_OFF voltage described in the electrical specifications. As long as the parameters stated in Table 4, "Absolute Maximum Limits," on page 7 are not violated, no current will flow through the Si1132. In the Off Mode, the Si1132 SCL and SDA pins do not interfere with other I<sup>2</sup>C devices on the bus. Keeping  $V_{DD}$  less than VDD\_OFF is not intended as a method of achieving lowest system current draw. The reason is that the ESD protection devices on the SCL, SDA and INT pins also from a current path through  $V_{DD}$ . If  $V_{DD}$  is grounded for example, then, current flow from system power to system ground through the SCL, SDA and INT pull-up resistors and the ESD protection devices.

Allowing V<sub>DD</sub> to be less than VDD\_OFF is intended to serve as a hardware method of resetting the Si1132 without a dedicated reset pin.

The Si1132 can also reenter the Off Mode upon receipt of either a general I<sup>2</sup>C reset or if a software reset sequence is initiated. When one of these software methods is used to enter the Off Mode, the Si1132 typically proceeds directly from the Off Mode to the Initialization Mode.

#### 3.2. Initialization Mode

When power is applied to  $V_{DD}$  and is greater than the minimum  $V_{DD}$  Supply Voltage stated in Table 1, "Recommended Operating Conditions," on page 4, the Si1132 enters its Initialization Mode. In the Initialization Mode, the Si1132 performs its initial startup sequence. Since the I<sup>2</sup>C may not yet be active, it is recommended that no I<sup>2</sup>C activity occur during this brief Initialization Mode period. The "Start-up time" specification in Table 1 is the minimum recommended time the host needs to wait before sending any I<sup>2</sup>C accesses following a power-up sequence. After Initialization Mode has completed, the Si1132 enters Standby Mode. The host must write 0x17 to the HW\_KEY register for proper operation.

#### 3.3. Standby Mode

The Si1132 spends most of its time in Standby Mode. After the Si1132 completes the Initialization Mode sequence, it enters Standby mode. While in Standby Mode, the Si1132 does not perform any measurements. However, the I<sup>2</sup>C interface is active and ready to accept reads and writes to the Si1132 registers. The internal Digital Sequence Controller is in its sleep state and does not draw much power. In addition, the INT output retains its state until it is cleared by the host.

I<sup>2</sup>C accesses do not necessarily cause the Si1132 to exit the Standby Mode. For example, reading Si1132 registers is accomplished without needing the Digital Sequence Controller to wake from its sleep state.

#### 3.4. Forced Conversion Mode

The Si1132 can operate in Forced Conversion Mode under the specific command of the host processor. The Forced Conversion Mode is entered if the ALS\_FORCE command is sent. Upon completion of the conversion, the Si1132 can generate an interrupt to the host if the corresponding interrupt is enabled.



#### 3.5. Autonomous Operation Mode

The Si1132 can be placed in the Autonomous Operation Mode where measurements are performed automatically without requiring an explicit host command for every measurement. The ALS\_AUTO command is used to place the Si1132 in the Autonomous Operation Mode.

The Si1132 updates the I<sup>2</sup>C registers for ALS automatically. Each measurement is allocated a 16-bit register in the I<sup>2</sup>C map. It is possible to operate the Si1132 without interrupts. When doing so, the host poll rate must be at least twice the frequency of the conversion rates for the host to always receive a new measurement. The host can also choose to be notified when these new measurements are available by enabling interrupts.

The conversion frequencies for the ALS measurements are set up by the host prior to the ALS\_AUTO command.



# 4. Programming Guide

#### 4.1. Command and Response Structure

All Si1132 I<sup>2</sup>C registers (except writes to the COMMAND register) are read or written without waking up the internal sequencer. A complete list of the I<sup>2</sup>C registers can be found in "4.5. I2C Registers" on page 24. In addition to the I<sup>2</sup>C Registers, RAM parameters are memory locations maintained by the internal sequencer. These RAM Parameters are accessible through a Command Protocol (see "4.6. Parameter RAM" on page 35). A complete list of the RAM Parameters can be found in "4.6. Parameter RAM" on page 35.

The Si1132 can operate either in Forced Measurement or Autonomous Mode. When in Forced Measurement mode, the Si1132 does not make any measurements unless the host specifically requests the Si1132 to do so via specific commands (refer to the Section 3.2). The CHLIST parameter needs to be written so that the Si1132 would know which measurements to make. The parameter MEAS\_RATE, when zero, places the internal sequencer in Forced Measurement mode. When in Forced Measurement mode, the internal sequencer wakes up only when the host writes to the COMMAND register. The power consumption is lowest in Forced Measurement mode (MEAS RATE = 0).

The Si1132 operates in Autonomous Operation mode when MEAS\_RATE is non-zero. The MEAS\_RATE represents the time interval at which the Si1132 wakes up periodically. Up to three measurements are made (ALS\_VIS, ALS\_IR and AUX) depending on which measurements are enabled via the upper bits of the CHLIST Parameter. All three measurements are made in the following sequence: ALS\_VIS, ALS\_IR and AUX.

The ALS Measurement group consists of the Visible Light Ambient Measurement (ALS\_VIS), the Infrared Light Ambient Measurement (ALS\_IR) and the Auxiliary measurement (AUX). Each measurement group has three measurements each. The Channel List (CHLIST) parameter enables the specific measurements for that measurement grouping.

Each measurement (ALS\_VIS, ALS\_IR, AUX) are controlled through a combination of I2C Register or Parameter RAM. Tables 7 to 9 below summarize the properties and resources used for each measurement.



#### 4.2. Command Protocol

The I<sup>2</sup>C map implements a bidirectional message box between the host and the Si1132 Sequencer. Host-writable I<sup>2</sup>C registers facilitate host-to-Si1132 communication, while read-only I<sup>2</sup>C registers are used for Si1132-to-host communication.

Unlike the other host-writable I<sup>2</sup>C registers, the COMMAND register causes the internal sequencer to wake up from Standby mode to process the host request.

When a command is executed, the RESPONSE register is updated. Typically, when there is no error, the upper four bits are zeros. To allow command tracking, the lower four bits implement a 4-bit circular counter. In general, if the upper nibble of the RESPONSE register is non-zero, this indicates an error or the need for special processing. The PARAM\_WR and PARAM\_RD registers are additional mailbox registers.

In addition to the registers in the I<sup>2</sup>C map, there are environmental parameters accessible through the Command/Response interface. These parameters are stored in the internal ram space. These parameters generally take more I<sup>2</sup>C accesses to read and write. The Parameter RAM is described in "4.6. Parameter RAM" on page 35.

For every write to the Command register, the following sequence is required:

- 1. Write 0x00 to Command register to clear the Response register.
- 2. Read Response register and verify contents are 0x00.
- 3. Write Command value from Table 5 into Command register.
- 4. Read the Response register and verify contents are now non-zero. If contents are still 0x00, repeat this step.

The Response register will be incremented upon the successful completion of a Command. If the Response register remains 0x00 for over 25 ms after the Command write, the entire Command process should be repeated from Step 1.

Step 4 above is not applicable to the Reset Command because the device will reset itself and does not increment the Response register after reset. No Commands should be issued to the device for at least 1 ms after a Reset is issued.

**COMMAND Register** PARAM\_W PARAM RD **Error Code in** Description Register **RESPONSE** Register R Register Name **Encoding** PARAM QUERY 100 aaaaa nnnn nnnn Reads the parameter pointed to by bitfield [4:0] and writes value to PARAM RD. See Table 12 for parameters. **√** PARAM SET 101 aaaaa dddd Sets parameter pointed by bitfield nnnn nnnn [4:0] with value in PARAM WR. and dddd writes value out to PARAM RD. See Table 12 for parameters. NOP 000 00000 Forces a zero into the RESPONSE register RESET 000 00001 Performs a software reset of the firmware Modifies I<sup>2</sup>C address **BUSADDR** 000 00010 Reserved 000 00011 Reserved 000 00100

**Table 5. Command Register Summary** 



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000 00101

Reserved

**Table 5. Command Register Summary (Continued)** 

COMMAND R	Register	PARAM_W	PARAM_RD	Error Code in	Deceription
Name	Encoding	R Register	Register	RESPONSE Register	Description
GET_CAL	0001 0010	_	_		Reports calibration data to I <sup>2</sup> C registers 0x22–0x2D
ALS_FORCE	000 00110	_	_	✓	Forces a single ALS measurement
Reserved	000 00111	_	_	_	- (19)
Reserved	000 01000	_	_	_	-0.9
Reserved	000 01001	_	_	_	70
ALS_PAUSE	000 01010	_	_	✓	Pauses autonomous ALS
Reserved	000 01011	_	_	_	
Reserved	000 01100	_	_	✓	
Reserved	000 01101	_	_	_ \	
ALS_AUTO	000 01110	_	_		Starts/Restarts an autonomous ALS Loop
Reserved	000 01111	_	_	-	_
Reserved	000 1xxxx	_	_	60	_

# **Table 6. Response Register Error Codes**

RESPONSE Register	Description
0000 cccc	NO_ERROR. The lower bit is a circular counter and is incremented every time a command has completed. This allows the host to keep track of commands sent to the Si1132. The circular counter may be cleared using the NOP command.
1000 0000	INVALID_SETTING. An invalid setting was encountered. Clear using the NOP command.
1000 1100	ALS_VIS_ADC_OVERFLOW. Indicates visible ambient light channel conversion overflow.
1000 1101	ALS_IR_ADC_OVERFLOW. Indicates infrared ambient light channel conversion overflow.
1000 1110	AUX_ADC_OVERFLOW. Indicates auxiliary channel conversion overflow.

## 4.3. Resource Summary

**Table 7. Resource Summary for Interrupts** 

	Channel Enable	Interrupt Status Output	Interrupt Enable
ALS Visible	EN_ALS_VIS in CHLIST[4]	ALS_INT[1:0] in IRQ_ STATUS[1:0]	ALS_IE[1:0] in IRQ_ENABLE[1:0]
ALS IR	EN_ALS_IR in CHLIST[5]		1000
Auxiliary Measurement	EN_AUX in CHLIST[6]	_ (0)	<i>N</i> –
Ç			
ot Reco			



Table 8. Resource Summary for ADC Parameters

		Table 8. R	. Resource Summary for ADC Parameters	arameters	4	
Measurement Channel	ADC Output	ADC Input Source	ADC Recovery Count	ADC High Signal Mode	ADC Clock Divider	ADC Alignment
ALS Visible	ALS_VIS_DATA1/ ALS_VIS_DATA0		VIS_ADC_REC in ALS_VIS_ADC_COUNTER [6:4]	VIS_RANGE in ALS_VIS_ADC_MISC[5]	ALS_VIS_ ADC_GAIN [3:0]	ALS_VIS_ ALIGN in ALS_ ENCODING[4]
ALS IR	ALS_IR_DATA1[7:0] / ALS_IR_DATA0[7:0]		IR_ADC_REC in ALS_IR_ADC_COUNTER [6:4]	IR_RANGE In ALS_IR_ADC_MISC[5]	ALS_IR_ ADC_GAIN [3:0]	ALS_IR_ ALIGN in ALS_ ENCODING[5]
Auxiliary Measurement	AUX_DATA1[7:0] / AUX_DATA0[7:0]	AUX_ADCMUX[7:0]	40%	I	I	I
	1		Rev. 1.2			21



**Table 9. Resource Summary for Hardware Pins** 

Pin Name	Output Drive Disable	Analog Voltage Input Enable
INT	INT_OE in INT_CFG[0]	ANA_IN_KEY[31:0]

The interrupts of the Si1132 are controlled through the INT\_CFG, IRQ\_ENABLE, IRQ\_MODE1, IRQ\_MODE2 and IRQ\_STATUS registers.

The INT hardware pin is enabled through the INT\_OE bit in the INT\_CFG register. The hardware essentially performs an AND function between the IRQ\_ENABLE register and IRQ\_STATUS register. After this AND function, if any bits are set, the INT pin is asserted. The host is responsible for clearing the interrupt by writing to the IRQ\_STATUS register. When the specific bits of the IRQ\_STATUS register is written with 1, that specific IRQ\_STATUS bit is cleared.

Typically, the host software is expected to read the IRQ\_STATUS register, stores a local copy, and then writes the same value back to the IRQ\_STATUS to clear the interrupt source. The INT\_CFG register is normally written with 1.

The IRQ\_MODE1, IRQ\_MODE2 and IRQ\_ENABLE registers work together to define how the internal sequencer sets bits in the IRQ\_STATUS register (and as a consequence, asserting the INT pin).

The ALS interrupts are described in Table 10.

Table 10. Ambient Light Sensing Interrupt Resources

IRQ_ENABLE[1:0]		Description
ALS_I	E[1:0]	
0	0	No ALS Interrupts
0	1	ALS_INT set after every ALS_VIS or UV sample



# 4.4. Signal Path Software Model

The following diagram gives an overview of the signal paths, along with the I<sup>2</sup>C register and RAM Parameter bit fields that control them. Sections with detailed descriptions of the I<sup>2</sup>C registers and Parameter RAM follow.

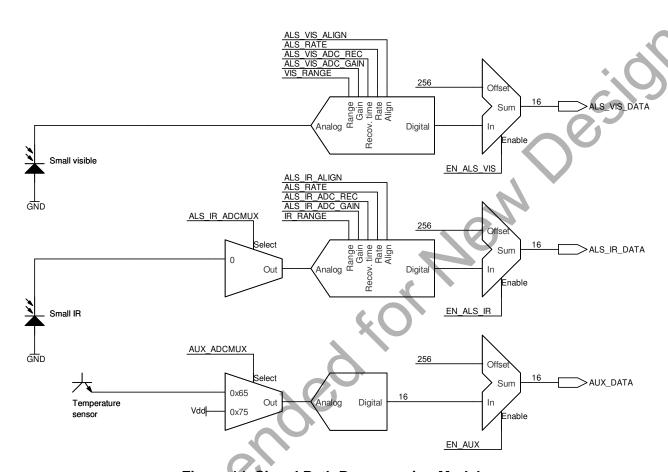


Figure 14. Signal Path Programming Model



Record

# 4.5. I<sup>2</sup>C Registers

Table 11. I<sup>2</sup>C Register Summary

I <sup>2</sup> C Register Name	Address	7	6	5	4	3	2	1	0	
PART_ID	0x00		PART_ID +							
REV_ID	0x01		REV_ID							
SEQ_ID	0x02				SEQ_	ID		0,		
INT_CFG	0x03								INT_OE	
IRQ_ENABLE	0x04								ALS_IE	
HW_KEY	0x07				HW_K	ΕΥ	110			
MEAS_RATE0	80x0				MEAS_R	ATE0	5			
MEAS_RATE1	0x09				MEAS_R	ATE1				
Reserved	0x0A				~					
Reserved	0x0B				KO,					
Reserved	0x0C									
Reserved	0x0D		20							
Reserved	0x0E		2	O						
Reserved	0x0F		0	<i>y</i>						
Reserved	0x10	C								
Reserved	0x11									
Reserved	0x12									
UCOEF0	0x13				UCOE	F0				
UCOEF1	0x14	) `			UCOE	F1				
UCOEF2	0x15				UCOE	F2				
UCOEF3	0x16				UCOE	F3				
PARAM_WR	0x17				PARAM_	_WR				
COMMAND	0x18				COMMA	ND				
RESPONSE	0x20		RESPONSE							
IRQ_STATUS	0x21			CMD_INT				ALS_	INT	
ALS_VIS_ DATA0	0x22				ALS_VIS_I	DATA0				



Table 11. I<sup>2</sup>C Register Summary (Continued)

I <sup>2</sup> C Register Name	Address	7	6	5	4	3	2	1	0	
ALS_VIS_ DATA1	0x23		ALS_VIS_DATA1							
ALS_IR_DATA0	0x24		ALS_IR_DATA0							
ALS_IR_DATA1	0x25				ALS_IR_	DATA1		5		
Reserved	0x26							(0)		
Reserved	0x27							)		
Reserved	0x28									
Reserved	0x29									
Reserved	0x2A						9			
Reserved	0x2B									
AUX_DATA0/ UVINDEX0	0x2C			AU	X_DATA0/l	JVINDEX	(0			
AUX_DATA1/ UVINDEX1	0x2D		AUX_DATA1/UVINDEX1							
PARAM_RD	0x2E	PARAM_RD								
CHIP_STAT	0x30	RUNNING SUSPEND SLEEP						SLEEP		
ANA_IN_KEY	0x3B- 0x3E				ANA_IN_	_KEY				

PAR	T II	$ \sim $	nv	nη
FAR		J ( <i>W</i>	UX	υu

Bit	7	6	5	4	3	2	1	0		
Name		PART_ID								
Туре				F	3			2/2		

Reset value = 0011 0010

## REV\_ID @ 0x1

Bit	7	6	5	4	3	2	1	0
Name				RE\	/_ID	0		
Туре				F	3			

Reset value = 0000 0000

## **SEQ\_ID @ 0x02**

Bit	7	6	5 4	3	2	1	0
Name			SE	EQ_ID			
Туре				R			

Reset value = 0000 1000

Bit	Name	Function
7:0	SEQ_ID	Sequencer Revision.
		0x08 Si1132-A10 (MAJOR_SEQ=1, MINOR_SEQ=0)



# INT\_CFG @ 0x03

Bit	7	6	5	4	3	2	1	0
Name								INT_OE
Туре							RW	RW

# Reset value = 0000 0000

Bit	Name	Function
7:2	Reserved	Reserved.
0	INT_OE	INT Output Enable.
		INT_OE controls the INT pin drive
		0: INT pin is never driven
		1: INT pin driven low whenever an IRQ_STATUS and its corresponding IRQ_ENABLE
		bits match

# IRQ\_ENABLE @ 0x04

Bit	7	6	5	4	3	2	1	0
Name								ALS_IE
Туре							R	W

## Reset value = 0000 0000

Bit	Name	Function
7:1	Reserved	Reserved.
0	ALS_IE	ALS Interrupt Enable.
	CO	Enables interrupts when VIS bit or UV bit in CHLIST is enabled.  0: INT never asserts due to VIS or UV activity  1: Assert INT pin whenever VIS or UV measurements are ready



HW	<b>KEY</b>	@	0x07
----	------------	---	------

Bit	7	7 6 5 4 3 2 1									
Name	HW_KEY										
Туре				R	W						

Reset value = 0000 0000

Bit	Name	Function
7:0	HW_KEY	The system must write the value 0x17 to this register for proper Si1132 operation.

# MEAS\_RATE0: MEAS\_RATE Data Word Low Byte @ 0x08

Bit	7	6	5	4	3	2	2	1	0
Name		MEAS_RATE[7:0]							
Туре				R	W				

Reset value = 0000 0000

Bit	Name	Function
7:0	MEAS_RATE[7:0]	MEAS_RATE1 and MEAS_RATE0 together form a 16-bit value: MEAS_RATE [15:0]. The 16-bit value, when multiplied by 31.25 μs, represents the time duration between
		wake-up periods where measurements are made. Once the device wakes up, all measurements specified in CHLIST are made.
		Note that for the Si1132 with SEQ_ID=0x01, there is a code error that places MEAS_RATE0 at 0x0A with MEAS_RATE1 at 0x08 instead. This will be fixed in
		future revisions of the Si1132.



MEAS_RATE1: MEAS_RATE Data Word High Byte @ 0x09	<b>MEAS</b>	RATE1: MEAS	RATE Data	Word High	Byte @ 0x09
--	-------------	-------------	-----------	-----------	-------------

Bit	7	6	5	4	3	2	1	0				
Name		MEAS_RATE[15:8]										
Туре				R	W			2/2)				

Reset value = 0000 0000

Bit	Name	Function
7:0	MEAS_RATE[15:8]	MEAS_RATE1 and MEAS_RATE0 together form a 16-bit value: MEAS_RATE[15:0]. The 16-bit value, when multiplied by 31.25 μs, represents the time duration between wake-up periods where measurements are made. Once the device wakes up, all measurements specified in CHLIST are made.  Note that for the Si1132 with SEQ_ID=0x01, there is a code error that places MEAS_RATE0 at 0x0A and MEAS_RATE1 at 0x08 instead. This will be fixed in future revisions of the Si1132.

# PARAM\_WR @ 0x17

Bit	7	6	5	4	3	2	1	0	
Name		PARAM_WR							
Туре				R	W				

Reset value = 0000 0000

Bit	Name	Function
7:0	PARAM_WR	Mailbox register for passing parameters from the host to the sequencer.



#### COMMAND @ 0x18

Bit	7	6	5	4	3	2	1	0			
Name	COMMAND										
Туре				RV	V			: (O)			

Reset value = 0000 0000

Bit	Name	Function
7:0	COMMAND	COMMAND Register.
		The COMMAND Register is the primary mailbox register into the internal sequencer. Writing to the COMMAND register is the only I <sup>2</sup> C operation that wakes the device from standby mode.

## RESPONSE @ 0x20

Bit	7	6	5	4 3	2	1	0				
Name		RESPONSE									
Туре				RW							

Reset value = 0000 0000

Bit	Name	Function
7:0	RESPONSE	The Response register is used in conjunction with command processing. When an error
		is encountered, the response register will be loaded with an error code. All error codes will have the MSB is set.
		The error code is retained until a RESET or NOP command is received by the
		sequencer. Other commands other than RESET or NOP will be ignored. However, any autonomous operation in progress continues normal operation despite any error.
		0x00–0x0F: No Error. Bits 3:0 form an incrementing roll-over counter. The roll over
		counter in bit 3:0 increments when a command has been executed by the Si1132. Once
		autonomous measurements have started, the execution timing of any command becomes non-deterministic since a measurement could be in progress when the
		COMMAND register is written. The host software must make use of the rollover counter
		to ensure that commands are processed.
		0x80: Invalid Command Encountered during command processing
		0x8C: ADC Overflow encountered during ALS-VIS measurement
X	•	0x8D: ADC Overflow encountered during ALS-IR measurement
	•	0x8E: ADC Overflow encountered during AUX measurement



#### IRQ\_STATUS @ 0x21

Bit	7	6	5	4	3	2	1	0
Name			CMD_INT					ALS_INT
Туре			RW		R	W.		

Reset value = 0000 0000

Bit	Name	Function
7:6	Reserved	Reserved.
5	CMD_INT	Command Interrupt Status.
4:2	Reserved	Reserved.
1:0	ALS_INT	ALS Interrupt Status. (Refer to Table 13 for encoding.)
Note: If the	he correspondin	g IRQ_ENABLE bit is also set when the IRQ_STATUS bit is set, the INT pin is asserted.

# ALS\_VIS\_DATA0: ALS\_VIS\_DATA Data Word Low Byte @ 0x22

Bit	7	6	5	4	3	2	1	0			
Name		ALS_VIS_DATA[7:0]									
Туре				R	W						

Reset value = 0000 0000

Bit	Name	Function
7:0		ALS VIS Data LSB. Once autonomous measurements have started, this register must be read after INT has asserted but before the next measurement is made. Refer to "AN498: Si114x Designer's Guide", section "5.6.2 Host Interrupt Latency".



# ALS\_VIS\_DATA1: ALS\_VIS\_DATA Data Word High Byte @ 0x23

Bit	7	6	5	4	3	2	1	0		
Name		ALS_VIS_DATA[15:8]								
Туре				R	W			· (O)		

Reset value = 0000 0000

Bit	Name	Function
7:0		ALS VIS Data MSB. Once autonomous measurements have started, this register
		must be read after INT has asserted but before the next measurement is made.
		Refer to "AN498: Si114x Designer's Guide", section "5.6.2 Host Interrupt Latency".

# ALS\_IR\_DATA0: ALS\_IR\_DATA Data Word Low Byte@ 0x24

Bit	7	6	5	4	3	2	1	0			
Name	ALS_IR_DATA[7:0]										
Туре				R'	W						

Reset value = 0000 0000

Bit	Name	Function
7:0	ALS_IR_DATA[7:0]	ALS IR Data LSB. Once autonomous measurements have started, this register must be read after INT has asserted but before the next measurement is made. Refer to "AN498: Si114x Designer's Guide", section "5.6.2 Host Interrupt Latency".

## ALS\_IR\_DATA1: ALS\_IR\_DATA Data Word High Byte @ 0x25

Bit	7 6	5	4	3	2	1	0		
Name		ALS_IR_DATA[15:8]							
Туре	<b>(</b> )		R'	W					

Reset value = 0000 0000

Bit	Name	Function
7:0		ALS IR Data MSB. Once autonomous measurements have started, this register must be read after INT has asserted but before the next measurement is made. Refer to "AN498: Si114x Designer's Guide", section "5.6.2 Host Interrupt Latency".



AUX_DATA0/UVINDEX0: AUX_DATA	Data Word Low Byte @ 0x2C
------------------------------	---------------------------

Bit	7	6	5	4	3	2	1	0		
Name		AUX_DATA[7:0]								
Туре				R	W			*(O)		

Reset value = 0000 0000

Bit	Name	Function
7:0		<b>AUX Data LSB.</b> Once autonomous measurements have started, this register must be read after INT has asserted but before the next measurement is made. Refer to "AN498: Si114x Designer's Guide", section "5.6.2 Host Interrupt Latency".

# AUX\_DATA1/UVINDEX1: AUX\_DATA Data Word High Byte @ 0x2D

Bit	7	6	5	4	3		2	1	0
Name		AUX_DATA[15:8]							
Туре				R	W				

Reset value = 0000 0000

Bit	Name	Function
7:0 AUX		<b>AUX Data MSB.</b> Once autonomous measurements have started, this register must be read after INT has asserted but before the next measurement is made. Refer to "AN498: Si114x Designer's Guide", section "5.6.2 Host Interrupt Latency".

## PARAM\_RD @ 0x2E

Bit	7 6	5	4	3	2	1	0
Name	60.	PARAM_RD					
Туре	00		R'	W			

Reset value = 0000 0000

Bit	Name	Function
7:0	PARAM_RD	Mailbox register for passing parameters from the sequencer to the host.



#### CHIP\_STAT @ 0x30

Bit	7	6	5	4	3	2	1	0
Name						RUNNING	SUSPEND	SLEEP
Туре						R	R	R

Reset value = 0000 0000

Bit	Name	Function
7:3	Reserved	Reserved
2	RUNNING	Device is awake.
1	SUSPEND	Device is in a low-power state, waiting for a measurement to complete.
0	SLEEP	Device is in its lowest power state.

## ANA\_IN\_KEY @ 0x3B to 0x3E

Bit	7	6	5	4	3	2	1	0
0x3B		ANA_IN_KEY[31:24]						
0x3C		ANA_IN_KEY[23:16]						
0x3D		ANA_IN_KEY[15:8]						
0x3E		ANA_IN_KEY[7:0]						
Туре				•	RW			

Reset value = 0000 0000

Bit	Name	Function
31:0	ANA_IN_KEY[31:0]	Reserved.



#### 4.6. Parameter RAM

Parameters are located in internal memory and are not directly addressable over I<sup>2</sup>C. They must be indirectly accessed using the PARAM\_QUERY and PARAM\_SET commands described in "4.2. Command Protocol" on page 18.

**Table 12. Parameter RAM Summary Table** 

Parameter Name	Offset	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
I2C_ADDR	0x00		-		I <sup>2</sup> C Address				
CHLIST	0x01	EN_UV	EN_AUX	EN_ALS_IR	EN_ALS_VIS			5	
Reserved	0x02			•				7)	
Reserved	0x03					<			
Reserved	0x04			Reserve	ed (always set t	o 0)			
Reserved	0x05					Reserv	ed (alwa	ays set	to 0)
ALS_ENCODING	0x06			ALS_IR_ ALIGN	ALS_VIS_ ALIGN	Reserve	ed (alwa	ays set	to 0)
Reserved	0x07				19				
Reserved	0x08								
Reserved	0x09								
Reserved	0x0A			XI	<del>)</del>				
Reserved	0x0B								
Reserved	0x0C								
Reserved	0x0D		Reserved (do not modify from default setting of 0x02)						
ALS_IR_ADCMUX	0x0E		ALS_IR_ADCMUX						
AUX_ADCMUX	0x0F		AUX ADC Input Selection						
ALS_VIS_ ADC_COUNTER	0x10		3	VIS_ADC_R	EC	Reserve	ed (alwa	ays set	to 0)
ALS_VIS_ADC_GAIN	0x11							LS_VI DC_G	
ALS_VIS_ADC_MISC	0x12		erved set to 0)	VIS_RANGE	Rese	rved (alwa	ays set	to 0)	
Reserved	0x13		Reserv	ved (do not mo	dify from defau	It setting o	of 0x40)		
Reserved	0x14– 0x15	Reserved (do not modify from default setting of 0x00)							
Reserved	0x1B	Reserved (do not modify from default setting of 0x00)							
Reserved	0x1C								
ALS_IR_ ADC_COUNTER	0x1D			IR_ADC_RE	EC	Reserve	ed (alwa	ays set	to 0)
ALS_IR_ADC_GAIN	0x1E							LS_IR	
ALS_IR_ADC_MISC	0x1F		erved set to 0)	IR_RANGE	Rese	erved (alwa	ays set	to 0)	



#### **I2C @ 0x00**

Bit	7	6	5	4	3	2	1	0
Name	I <sup>2</sup> C Address[7:0]							
Туре	RW							+ 0

Reset value = 0000 0000

Bit	Name	Function
7:0		Specifies a new I <sup>2</sup> C Address for the device to respond to. The new address takes
		effect when a BUSADDR command is received.

#### CHLIST @ 0x01

Bit	7	6	5	4	3 2	1	0
Name	EN_UV	EN_AUX	EN_ALS_IR	EN_ALS_VIS			
Туре	RW						

Reset value = 0000 0000

Bit	Name	Function
7	EN_UV	Enables UV Index, data stored in AUX_DATA1[7:0] and AUX_DATA0[7:0]
6	EN_AUX	Enables Auxiliary Channel, data stored in AUX_DATA1[7:0] and AUX_DATA0[7:0].
5	EN_ALS_IR	Enables ALS IR Channel, data stored in ALS_IR_DATA1[7:0] and ALS_IR_DATA0[7:0].
4	EN_ALS_VIS	Enables ALS Visible Channel, data stored in ALS_VIS_DATA1[7:0] and ALS_VIS_DATA0[7:0].
3:0	Reserved	

**Note:** For proper operation, CHLIST must be written with a non-zero value before forced measurements or autonomous operation is requested.



### ALS\_ENCODING @ 0x06

Bit	7	6	5	4	3	2	1	0
Name			ALS_IR_ALIGN	ALS_VIS_ALIGN				. (
Туре			RW	RW				·. (O)

Reset value = 0000 0000

Bit	Name	Function
7:6	Reserved	
5	ALS_IR_ALIGN	When set, the ADC reports the least significant 16 bits of the 17-bit ADC when performing ALS VIS Measurement. Reports the 16 MSBs when cleared.
4	ALS_VIS_ALIGN	When set, the ADC reports the least significant 16 bits of the 17-bit ADC when performing ALS IR Measurement. Reports the 16 MSBs when cleared.
3:0	Reserved	Always set to 0.

## ALS\_IR\_ADCMUX @ 0x0E

Bit	7	6	5	4	3	2	1	0
Name		ALS_IR_ADCMUX						
Туре				R	W			

Bit	Name	Function
7:0	ALS_IR_ADCMUX	Selects ADC Input for ALS_IR Measurement.
		0x00: Small IR photodiode



## AUX\_ADCMUX @ 0x0F

Bit	7	6	5	4	3	2	1	0
Name		AUX_ADCMUX[7:0]						
Туре		RW						÷

## Reset value = 0110 0101

Bit	Name	Function
7:0		Selects input for AUX Measurement. These measurements are referenced to GND.  0x65: Temperature (Should be used only for relative temperature measurement. Absolute Temperature not guaranteed)  0x75: V <sub>DD</sub> voltage

## ALS\_VIS\_ADC\_COUNTER @ 0x10

Bit	7	6	5	4	3	2	1	0
Name		VIS	_ADC_REC[	[2:0]				
Туре		RW	R/W	R/W	>			

## Reset value = 0111 0000

Bit	Name	Function
7	Reserved	
6:4	VIS_ADC_REC[2:0]	Recovery period the ADC takes before making a ALS-VIS measurement. 000: 1 ADC Clock (50 ns times 2^ALS_VIS_ADC_GAIN) 001: 7 ADC Clock (350 ns times 2^ALS_VIS_ADC_GAIN) 010: 15 ADC Clock (750 ns times 2^ALS_VIS_ADC_GAIN) 011: 31 ADC Clock (1.55 µs times 2^ALS_VIS_ADC_GAIN) 100: 63 ADC Clock (3.15 µs times 2^ALS_VIS_ADC_GAIN) 101: 127 ADC Clock (6.35 µs times 2^ALS_VIS_ADC_GAIN) 110: 255 ADC Clock (12.75 µs times 2^ALS_VIS_ADC_GAIN) 111: 511 ADC Clock (25.55 µs times 2^ALS_VIS_ADC_GAIN) The recommended VIS_ADC_REC value is the one's complement of ALS_VIS_ADC_GAIN.
3:0	Reserved	Always set to 0.



# ALS\_VIS\_ADC\_GAIN @ 0x11

Bit	7	6	5	4	3	2	1	0
Name						ALS_V	/IS_ADC_GA	IN[2:0]
Туре						RW	R/W	• RW

## Reset value = 0000 0000

Bit	Name	Function
7:3	Reserved	
2:0	ALS_VIS_ADC_GAIN[2:0]	Increases the ADC integration time for ALS Visible measurements by a factor of (2 ^ ALS_VIS_ADC_GAIN). This allows visible light measurement under dark glass. The maximum gain is 128 (0x7). For Example:  0x0: ADC Clock is divided by 1  0x4: ADC Clock is divided by 16  0x6: ADC Clock is divided by 64

# ALS\_VIS\_ADC\_MISC @ 0x12

Bit	7	6	5	4	3	2	1	0
Name			VIS_RANGE	O				
Туре			RW	<i>y</i>				

## Reset value = 0000 0000

Bit	Name	Function
7:6	Reserved	
5		When performing ALS-VIS measurements, the ADC can be programmed to operate in high sensitivity operation or high signal range.  The high signal range is useful in operation under direct sunlight.  O: Normal Signal Range  1: High Signal Range (Gain divided by 14.5)
4:0	Reserved	



## ALS\_IR\_ADC\_COUNTER @ 0x1D

Bit	7	6	5	4	3	2	1	0
Name		IR_ADC_REC[2:0]						
Туре			RW					* (O)

Reset value = 0111 0000

Bit	Name	Function
7	Reserved	
6:4	IR_ADC_REC[2:0]	Recovery period the ADC takes before making a ALS-IR measurement. 000: 1 ADC Clock (50 ns times 2^ALS_IR_ADC_GAIN) 001: 7 ADC Clock (350 ns times 2^ALS_IR_ADC_GAIN) 010: 15 ADC Clock (750 ns times 2^ALS_IR_ADC_GAIN) 011: 31 ADC Clock (1.55 µs times 2^ALS_IR_ADC_GAIN) 100: 63 ADC Clock (3.15 µs times 2^ALS_IR_ADC_GAIN) 101: 127 ADC Clock (6.35 µs times 2^ALS_IR_ADC_GAIN) 110: 255 ADC Clock (12.75 µs times 2^ALS_IR_ADC_GAIN) 111: 511 ADC Clock (25.55 µs times 2^ALS_IR_ADC_GAIN) 111: 511 ADC Clock (25.55 µs times 2^ALS_IR_ADC_GAIN) 111: 511 ADC Clock (25.55 µs times 2^ALS_IR_ADC_GAIN)
3:0	Reserved	Always set to 0.



# ALS\_IR\_ADC\_GAIN @ 0x1E

Bit	7	6	5	4	3	2	1	0
Name						ALS_I	IR_ADC_GAI	N[2:0]
Туре						R/W	R/W	R/W

## Reset value = 0000 0000

Bit	Name	Function
7:3	Reserved	
2:0	ALS_IR_ADC_GAIN[2:0]	Increases the ADC integration time for IR Ambient measurements by a factor of (2 ^ ALS_IR_ADC_GAIN). The maximum gain is 128 (0x7). For Example:  0x0: ADC Clock is divided by 1  0x4: ADC Clock is divided by 16  0x6: ADC Clock is divided by 64

## ALS\_IR\_ADC\_MISC @ 0x1F

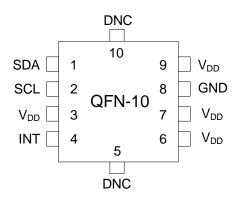
Bit	7	6	5	4	3	2	1	0
Name			IR_RANGE	0				
Туре			RW					

## Reset value = 0000 0000

Bit	Name	Function
7:6	Reserved	
5		When performing ALS-IR measurements, the ADC can be programmed to operate in high sensitivity operation or high signal range.  The high signal range is useful in operation under direct sunlight.  0: Normal Signal Range  1: High Signal Range (Gain divided by 14.5)
4:0	Reserved	Write operations to this RAM parameter must preserve this bit-field value using read-modify-write.



# 5. Pin Descriptions



**Table 13. Pin Descriptions** 

Pin	Name	Туре	Description
1	SDA	Bidirectional	I <sup>2</sup> C Data.
2	SCL	Input	I <sup>2</sup> C Clock.
3	V <sub>DD</sub>	Power	Power Supply. Voltage source.
4	INT	Bidirectional	Interrupt Output.  Open-drain interrupt output pin. Must be at logic level high during power-up sequence to enable low power operation.
5	DNC		Do Not Connect. This pin is electrically connected to an internal Si1132 node. It should remain unconnected.
6	V <sub>DD</sub>	Power	Power Supply. Voltage source.
7	V <sub>DD</sub>	Power	Power Supply. Voltage source.
8	GND	Power	Ground. Reference voltage.
9	V <sub>DD</sub>	Power	Power Supply. Voltage source.
10	DNC		Do Not Connect. This pin is electrically connected to an internal Si1132 node. It should remain unconnected.



# 6. Ordering Guide

Part Number	Package	
Si1132-A10-GMR	QFN-10	





# 7. Package Outline: 10-Pin QFN

Figure 15 illustrates the package details for the Si1132 QFN package. Table 14 lists the values for the dimensions shown in the illustration.

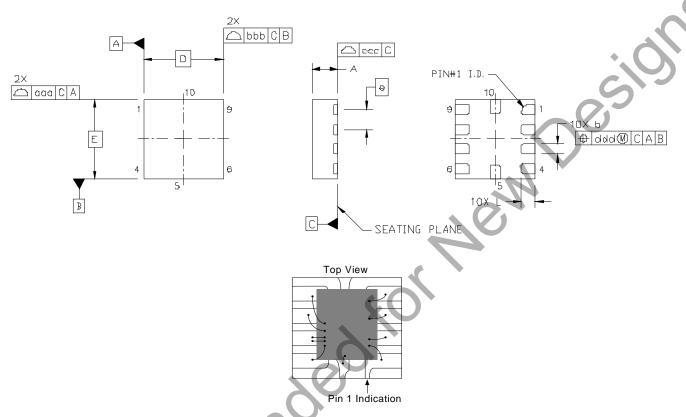


Figure 15. QFN Package Diagram Dimensions

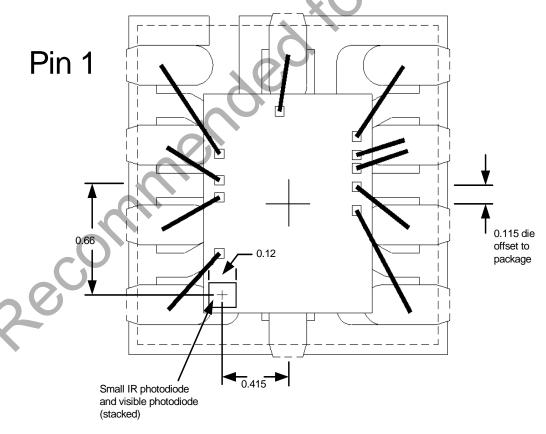


		_			
Dimension	Min	Nom	Max		
Α	0.55	0.65	0.75		
b	0.20	0.25	0.30		
D		2.00 BSC.			
е	0.50 BSC.				
Е	2.00 BSC.				
L	0.30	0.35	0.40		
aaa		0.10			
bbb	0.10				
ccc	0.08				
ddd		0.10	10		

**Table 14. Package Diagram Dimensions** 

### Notes:

- 1. All dimensions shown are in millimeters (mm).
- 2. Dimensioning and Tolerancing per ANSI Y14.5M-1994.



**Figure 16. Photodiode Centers** 



# 8. Suggested PCB Land Pattern

Figure 17 illustrates the PCB land pattern details for the Si1132. Table 15 lists the values for the dimensions shown in the illustration.

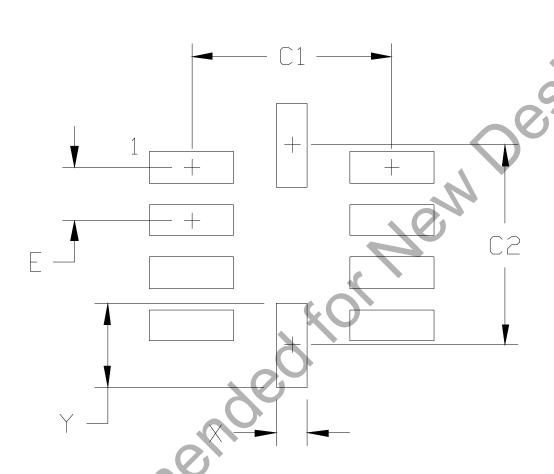


Figure 17. PCB Land Pattern



**Table 15. PCB Land Pattern Dimensions** 

Dimension	mm
C1	1.90
C2	1.90
E	0.50
X	0.30
Y	0.80

#### Notes:

#### General

- 1. All dimensions shown are in millimeters (mm).
- 2. This Land Pattern Design is based on the IPC-7351 guidelines.
- All dimensions shown are at Maximum Material Condition (MMC). Least Material Condition (LMC) is calculated based on a Fabrication Allowance of 0.05 mm.

#### Solder Mask Design

**4.** All metal pads are to be non-solder mask defined (NSMD). Clearance between the solder mask and the metal pad is to be 60 mm minimum, all the way around the pad.

### Stencil Design

- **5.** A stainless steel, laser-cut and electro-polished stencil with trapezoidal walls should be used to assure good solder paste release.
- 6. The stencil thickness should be 0.125 mm (5 mils).
- 7. The ratio of stencil aperture to land pad size should be 1:1 for all pads.

## Card Assembly

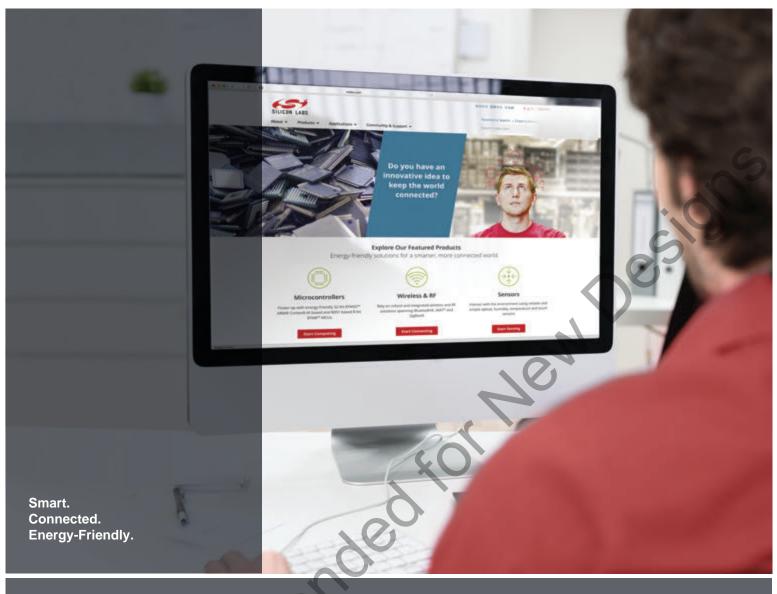
- 8. A No-Clean, Type-3 solder paste is recommended.
- **9.** The recommended card reflow profile is per the JEDEC/IPC J-STD-020D specification for Small Body Components.



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